



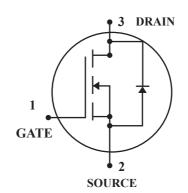
Small Signal MOSFET

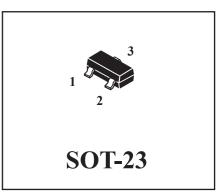
N-Channel



Features:

*Low On-Resistance: 3Ω
*Low Input Capacitance: 25PF
*Low Out put Capacitance: 6PF
*Low Threshole:1.5V(TYE)
*Fast Switching Speed:7.5ns





Maximum Ratings (TA=25°C Unless Otherwise Specified)

Rating	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	60	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current (TA=25°C)	I _D	250	mA
Pulsed Drain Current ⁽¹⁾	I _{DM}	1300	mA
Power Dissipation (TA=25 °C)	P _D	350	mW
Maximax Junction-to-Ambient	R _{ÐJA}	357	°C/W
Operating Junction and Storage Temperature Range	T _J ,Tstg	-55 to 150	°C

Device Marking

2N7002=7002

Note 1:

Pulse Width Limited by Maximum Junction Temperature

2N7002



Electrical Characteristics (TA=25 °C Unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Static					
Drain-Source Breakdown Voltage V _{GS} =0V, I _D =10 uA	V _{(BR)DSS}	60	70		V
Gate-Threshold Voltage V _{DS} =V _{GS} , I _D =250 uA	V _{GS (th)}	1	1.5	2.5	V
Gate-body Leakage V _{DS} =0V,V _{GS} =15V	I _{GSS}	-	-	100	nA
Zero Gate Voltage Drain Current V_{DS} =60V, V_{GS} =0V V_{DS} =60V, V_{GS} =0V, V_{j} =125 $^{\circ}$ C	I _{DSS}	-	-	1 500	uA
On-State Drain Current (2) V _{GS} =10V, V _{DS} =7.5V V _{GS} =4.5V, V _{DS} =10V	I _{D (on)}	800 500	1300 700	-	mA
Drain-Source On-Resistance $^{(2)}$ V_{GS} =10V, I_D =250mA V_{GS} =4.5V, I_D =200mA	r _{DS (on)}	- -	1.5 2.0	3 4	Ω
Forward Transconductance ⁽²⁾ V _{DS} =15V, I _D =200mA	9 _{fs}	-	300	-	mS
Diode Forward Voltage I _S =200mA, V _{GS} =0V	V _{SD}	-	0.85	1.2	V
Dynamic(1)	•		•		

Total Gate Charge V_{DS} =30V, V_{GS} =10V, I_D =250mA	Qg	-	0.6	1.0	
Gate-Source Charge V _{DS} =30V, V _{GS} =10V, I _D =250mA	Qgs	-	0.06	-	nC
Gate-Drain Charge V _{DS} =30V, V _{GS} =10V, I _D =250mA	Qgd	-	0.06	-	
Input Capacitance V _{DS} =25V, V _{GS} =0V, f=1MHZ	C _{iss}	-	25	-	
Output Capacitance V _{DS} =25V, V _{GS} =0V, f=1MHZ	C _{oss}	-	6	-	PF
Reverse Transfer Capacitance V _{DS} =25V, V _{GS} =0V, f=1MHZ	C _{rss}	-	1.2	-	

$Switching \ (1) \ (3)$

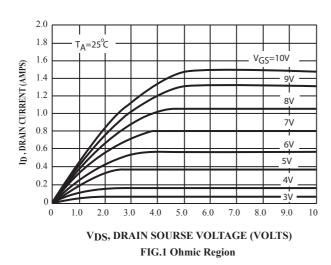
Turn-On Time V_{DD} =30V, R_L =200 Ω , I_D =100mA	t _{d(on)}	-	7.5	20	nS
$V_{GEN}=10V, R_{G}=10\Omega$	t _r	ı	6.0	-	
Turn-Off Time V_{DD} =30V, R_L =200 Ω , I_D =100mA	t _{d(off)}	1	7.5	20	nS
$V_{GEN}=10V, R_{G}=10\Omega$	t _f	-	3.0	-	

Note: 1. For Design Aid Only not Subject to Production Testing.

- 2. Pulse Test : PW≤300µs, Duty Cycle ≤2%
- ${\it 3. Switching Time is Essentially Independent of Operating Temperature}\;.$

WEITRON





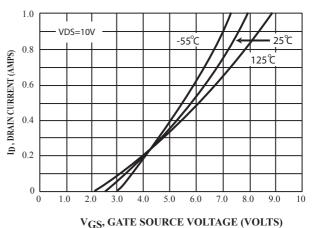
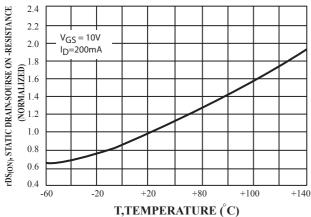


FIG.2 Transfer Characteristics



T,TEMPERATURE (°C)
FIG.3 Temperature Versus Static
Drain-Sourse On-Resistance

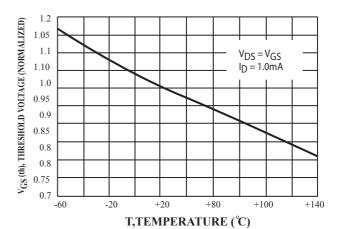
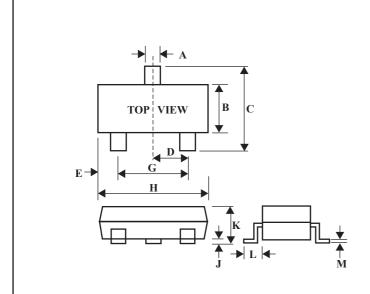


FIG.4 Temperature Versus Gate Threshold Voltage



SOT-23 Outline Dimension



	SOT-23			
Dim	Min	Max		
A	0.35	0.51		
В	1.19	1.40		
C	2.10	3.00		
D	0.85	1.05		
E	0.46	1.00		
G	1.70	2.10		
Н	2.70	3.10		
J	0.01	0.13		
K	0.89	1.10		
L	0.30	0.61		
M	0.076	0.25		